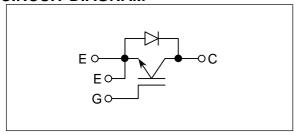
MBN400GR12

[Rated 400A/1200V, Single-pack type]

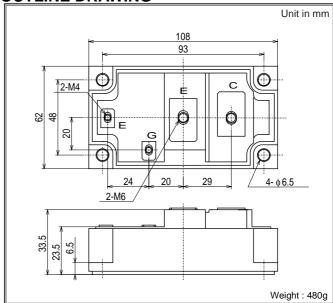
FEATURES

- Low saturation voltage and high speed.
- Low turn-OFF switching loss.
- Low noise due to build-in free-wheeling diode.
 (<u>Ultra Soft and Fast recovery Diode (USFD)</u>)
- High reliability structure.
- Isolated heat sink (terminals to base).

CIRCUIT DIAGRAM



OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS($T_c=25^{\circ}C$)

ABOOLOTE MAXIMOM NATINGO(1 _C -23 0)								
Item		Symbol	Unit	Value				
Collector-Emitter Voltage		V _{CES}	V	1200				
Gate-Emitter Voltage		V_{GES}	V	±20				
Collector Current	DC	I _C	۸	400				
	1ms	I _{CP}	A	800				
Forward Current	DC	I _F	۸	400 *1				
	1ms	I _{FM}	A	800				
Collector Power Dissipation		P _c	W	2080				
Junction Temperature		T _i	°C	-40 ~ +150				
Storage Temperature		T _{stg}	°C	-40 ~ +125				
Isolation Voltage		V_{iso}	V_{RMS}	2500(AC 1 minute)				
Screw Torque	Terminals (M4/M6)		N⋅m (kgf⋅cm)	1.37(14) / 2.94(30) *2				
	Mounting	1 –		2.94(30) *3				

Notes; *1: RMS current of Diode ≤ 120 Arms

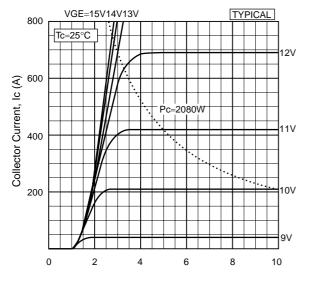
*2: Recommended value 1.18 / 2.45 N·m (12 / 25 kgf·cm)

*3: Recommended value 2.45 N·m (25 kgf·cm)

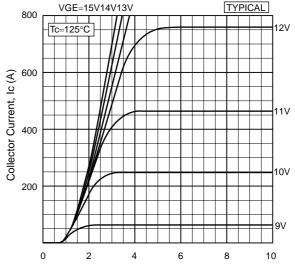
CHARACTERISTICS (T_c=25°C)

Item		Symbol	Unit	Min.	Typ.	Max.	Test Conditions
Collector-Emitter Cut-Off Current		I _{CES}	mA	_	_	1.0	V _{CE} =1200V, V _{GE} =0V
Gate-Emitter Leakage Current		I _{GES}	nA	_	_	±500	V _{GE} =±20V, V _{CE} =0V
Collector-Emitter Saturation Voltage		V _{CE(sat)}	V	_	2.2	2.8	I _C =400A, V _{GE} =15V
Gate-Emitter Threshold Voltage		$V_{GE(TO)}$	V	_	_	10	V _{CE} =5V, I _C =400mA
Input Capacitance		C _{ies}	pF	_	37000	_	V _{CE} =10V, V _{GE} =0V, f=1MHz
Switching Times	Rise Time	t _r	μs	_	0.25	0.7	V _{cc} =600V
	Turn-ON Time	t _{on}		_	0.4	0.9	$R_L=1.5\Omega$
	Fall Time	t _f		_	0.2	0.35	$R_{G}=2.7\Omega$ *4
	Turn-Off Time	t _{off}		_	0.7	1.1	V _{GE} =±15V
Peak Forward Voltage Drop		V_{FM}	V	_	2.5	3.5	I _F =400A, V _{GE} =0V
Reverse Recovery Time		t _{rr}	μS	_	_	0.4	I _F =400A, V _{GE} =-10V, di/dt=400A/μs
Thermal Impedance	IGBT	R _{th(j-c)}	°C/W	-	_	0.06	Junction to case
	FWD	R _{th(j-c)}				0.10	

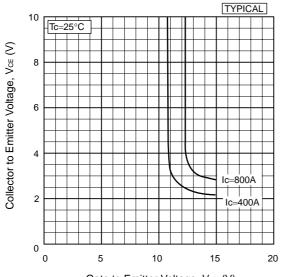
Notes; *4:R_G value is the test condition's value for decision of the switching times, not recommended value, please determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted. Remark; The specification given herein, is subject to change without prior notice to improve product characteristics.



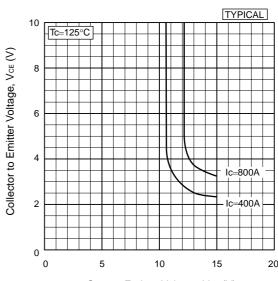
Collector to Emitter Voltage, V_{CE} (V) Collector current vs. Collector to Emitter voltage



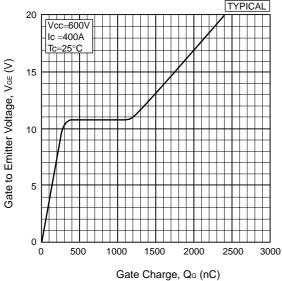
Collector to Emitter Voltage, VcE (V)
Collector current vs. Collector to Emitter voltage



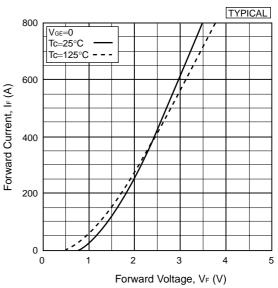
 $\label{eq:Gate to Emitter Voltage, Vge} Gate \ to \ Emitter \ voltage \ vs. \ Gate \ to \ Emitter \ voltage$



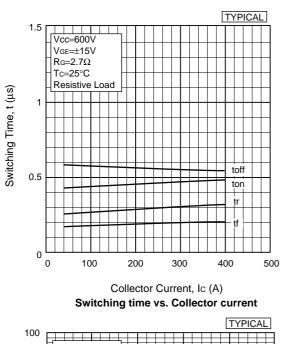
Gate to Emitter Voltage, V_{GE} (V) Collector to Emitter voltage vs. Gate to Emitter voltage

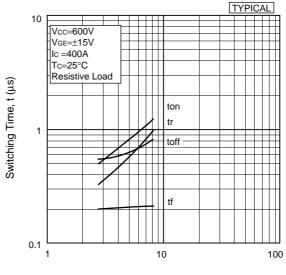


Gate charge characteristics

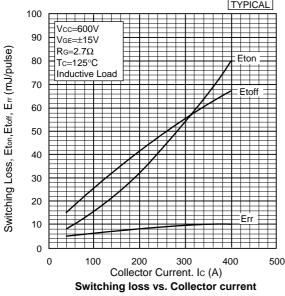


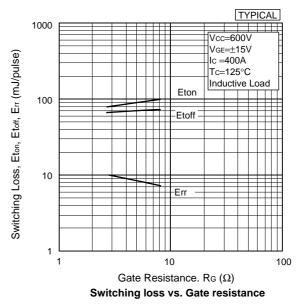
Forward voltage of free-wheeling diode

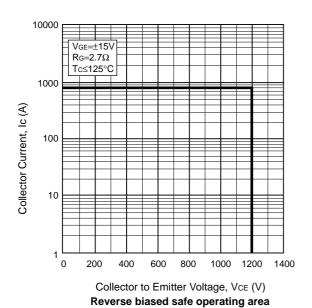


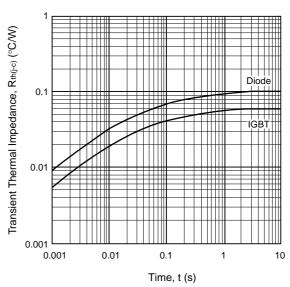












HITACHI POWER SEMICONDUCTORS

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